

IN THE SPECIFICATION

Please amend the Title on page 1 as follows:

SEMICONDUCTOR DEVICE INCLUDING GATE WIRING, MAIN  
ELECTRODES AND CONNECTING PLATE CONNECTED ONTO SAID MAIN  
ELECTRODES

Please amend the paragraph at page 13, lines 19-25 as follows:

Fig. 8 shows a plan view of the semiconductor device of this embodiment. Here 801 ~~denotes a semiconductor substrate~~, 802 denotes a lead frame, 803 denotes a strap, 804 denotes a gate wire, and 805 denotes a gate wiring. 806 denotes an application region of ultrasonic waves. Fig. 9 is fragmentary sectional view showing an outline of a section taken along the line C-C' in Fig. 8. In Fig. 9, 801 denotes a semiconductor substrate.